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Name of conveying party(ies)

101470344

JVER SHEET

-PATENTS ONLY-

To: Honorable Commissioner of Patents and Trademarks:

	b) M c) Se d) Ry e) Ke	imio Momose (amoru yamamoto eiichi Akimoto yosuke Fukuchi enichirou Ikeda azuhiro Matsushita				0965	TV 230		
2.	Name a)	and address of rece Name: Address:	Honda Giken Ky 1-1, Minami Ao	party(ies): ida Giken Kyogyo Kabushiki Kaisha Minami Aoyame 2-chome ato-ku, Tokyo 107-8556					
	b)	Name: Address:	RCD Engineerin 3-7, Hirabayashi Suminoe-ku, Osa Osaka, JAPAN	iminami 1	d. I-chome				
3.	Nature	of conveyance Assignment Security Agreem Other	ent		Merger Change of Name License Agreeme	nt			
	Execution Date: August 14, 2000								
4.	Application Number(s) or Patent Number(s): Unassigned								
5.	The title of the (new) application is: LUBRICANT COAT FORMING APPARATUS Please send all correspondence concerning this (these) documents to:								
			HICKMAN COL P.O. Box 52037 Palo Alto, CA 94 Tel. No.: (650) 4 Fax No.: (650) 4	4303-074 70-7430	& HUGHES, LLP				
6.	Total number of applications and patents involved: 1								
7.	Total fee (37 CFR 3.41): \$40.00								
		Enclosed Authorized to be (Order No. FUJI)		it Accour	nt No. 50-0384				
8.	To the loopy is	o the best of my knowledge and belief, the foregoing information is true and correct and any attached opy is a true copy of the original document.							
Date:	Septem	ber 7, 2000			Hickman ation No. 28,516		-		

Attorney Docket No. FUJI1P005

(Revised 01/96)

PATENT

REEL: 011095 FRAME: 0028

ASSIGNMENT OF PATENT APPLICATION

(Accompanying Application)

				•					
applica	Whereas I/we t tion entitled:	he undersigned inventor(s) have invented co	ertain new	and useful improvements as set forth in the patent					
for which		COAT FORMING APPARATUS ecuted an application for a United States Let	ters Paten	†					
TOT WITH				thich is hereby acknowledged, I/we the undersigned					
invento	r(s) hereby:			men is nevery deknowledged, 1/ we the undersigned					
1)	Sell(s), assign(s	Sell(s), assign(s) and transfer(s) to HONDA GIKEN KOGYO KABUSHIKI KAISHA and RCD ENGINEERING CO., LITD. Japanese corporations having a place of business.							
title and	d interest in any	an and Osaka, Japan	, (herei osed in, a	nafter referred to as "ASSIGNEE"), the entire right pplication(s) based upon, and Patent(s) (including					
2) any div		request the Commissioner of Patents to issue tion(s), substitutes(s) or reissue(s) thereof to		all Letters Patents resulting from said application or GNEE.					
	bly necessary in		plication,	SSIGNEE's expense, perform any acts which are as well as any derivative and applications thereof, from such applications.					
-	Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the Assignee, its successors, signs and other legal representative, and shall be binding upon the inventor(s), as well as the inventor's heirs, legal presentatives and assigns.								
5) conflict	Warrant and reps with this assign		not enter i	nto any assignment, contract, or understanding that					
	Signed on the d	ate(s) indicated beside my (our) signature(s)							
1)	Signature: Typed Name:	Kimio Momose	Date:	August 14,2000					
2)	Signature: Typed Name:	Kimio Me Mase Kimio MOMOSE Mamoru Yamamoto Mamoru Yamamoto Seiichi afoimoto	Date:	<u>August 14,</u> 2000					
3)	Signature: Typed Name:	Seiichi AKTMOTO	Date:	<u>August 14,</u> 2000					
4)	Signature: Typed Name:	RYOSUKE FUKUCHI RYOSUKE FUKUCHI	Date:	August 14, 2000					
5)	Signature: Typed Name:	Kenichirou Jkeda Kenichirou IKEDA	Date:	August 14, 2000					
6)	Signature: Typed Name:	Kazuhira mulsushita	Date:	August 14, 2000					
United	This assignment States of America	ea, then it should be signed before two witnes	ry Public is	f within the United States of America. If outside the lso sign below:					
1)	Signature:	h. Iwata		Date: August 14, 2000					
2)	Signature:	B. Anfach.		Date: August 14, 2000					

RECORDED: 09/07/2000

PATENT REEL: 011095 FRAME: 0029